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Vishay Siliconix

P-Channel 20 V (D-S) MOSFET



Marking code: AX

PRODUCT SUMMARY						
V _{DS} (V)	-20					
$R_{DS(on)}$ max. (Ω) at $V_{GS} = -4.5 \text{ V}$	0.038					
$R_{DS(on)}$ max. (Ω) at $V_{GS} = -2.5 \text{ V}$	0.046					
$R_{DS(on)}$ max. (Ω) at $V_{GS} = -1.8 \text{ V}$	0.060					
Q _g typ. (nC)	18					
I _D (A) ^a	-6					
Configuration	Single					

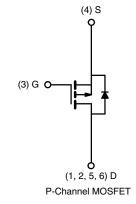
FEATURES

- TrenchFET® power MOSFET
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



APPLICATIONS

- · Load switch
- Notebook



ORDERING INFORMATION	
Package	TSOP-6
Lead (Pb)-free	Si3433CDV-T1-E3
Lead (Pb)-free and halogen-free	Si3433CDV-T1-GE3

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	-20	V	
Gate-source voltage		V _{GS}	± 8		
	T _C = 25 °C		-6 ^a		
Continuous dusin surrent /T 150 °C)	T _C = 70 °C		-6 ^a		
Continuous drain current (T _J = 150 °C)	T _A = 25 °C	I _D	-5.2 ^{b, c}		
	T _A = 70 °C		-4.2 ^{b, c}	А	
Pulsed drain current		I _{DM}	-20		
	T _C = 25 °C		-2.7		
Continuous source-drain diode current	T _A = 25 °C	I _S	-1.3 ^{b, c}		
	T _C = 25 °C		3.3		
Maximum power dissipation	T _C = 70 °C		2.1		
	T _A = 25 °C	P _D	1.6 ^{b, c}	W	
	T _A = 70 °C		1 b, c		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C	

THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYPICAL	MAXIMUM	UNIT		
Maximum junction-to-ambient b, d	t ≤ 5 s	R_{thJA}	60	80	°C/W	
Maximum junction-to-foot (drain)	Steady state	R_{thJF}	25	38	C/VV	

Notes

- a. Package limited
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 5 s d. Maximum under steady state conditions is 110 °C/W



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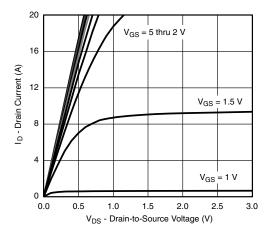
PARAMETER SYMBO		TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static					L	
Drain-source breakdown voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-20	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$		-	-18	-	1400
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = -250 μA	_	3	-	mV/°C
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \mu A$	-0.4	-	-1	V
Gate-source leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$	-	-	± 100	nA
Zana and a self-an admit a second	1 . 1	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	-1	μΑ
Zero gate voltage drain current	I _{DSS}	V _{DS} = -20 V, V _{GS} = 0 V, T _J = 85 °C	-	-	-10	
On-state drain current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	-20	-	-	Α
) /	$V_{GS} = -4.5 \text{ V}, I_D = -5.2 \text{ A}$	-	0.031	0.038	
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = -2.5 \text{ V}, I_D = -4.8 \text{ A}$	-	0.037	0.046	Ω
	`	$V_{GS} = -1.8 \text{ V}, I_D = -2 \text{ A}$	-	0.046	0.060	1
Forward transconductance a	9 _{fs}	$V_{DS} = -6 \text{ V}, I_D = -5.2 \text{ A}$	-	20	-	S
Dynamic ^b						
Input capacitance	C _{iss}		-	1300	-	pF
Output capacitance	Coss	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	210	=.	
Reverse transfer capacitance	C _{rss}		-	180	-	
·	Qg	$V_{DS} = -10 \text{ V}, V_{GS} = -8 \text{ V}, I_D = -5.2 \text{ A}$	-	30	45	nC
Total gate charge			-	18	27	
Gate-source charge	Q _{gs}	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -5.2 \text{ A}$	-	2.1	=.	
Gate-drain charge	Q _{qd}		-	4.8	- .	
Gate resistance	R _g	f = 1 MHz	-	6	-	Ω
Turn-on delay time	t _{d(on)}		-	20	30	
Rise time	t _r	V_{DD} = -10 V, R_L = 2.4 Ω	-	22	35	1
Turn-off delay time	t _{d(off)}	$I_D \cong -4.2 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$	-	50	75	
Fall time	t _f		-	20	30	1
Turn-on delay time	t _{d(on)}		-	10	15	ns -
Rise time	t _r	$V_{DD} = -10 \text{ V}, R_1 = 2.4 \Omega$	-	12	25	
Turn-off delay time	t _{d(off)}	$I_D \cong -4.2 \text{ A}, V_{GEN} = -8 \text{ V}, R_g = 1 \Omega$	-	50	75	
Fall time	t _f		-	15	25	
Drain-source body diode characteristic	s					
Continuous source-drain diode current	Is	T _C = 25 °C	_	_	-2.7	
Pulse diode forward current ^a	I _{SM}	-	-	-	-20	A
Body diode voltage	V _{SD}	I _S = -4.2 A	-	-0.8	-1.2	V
Body diode reverse recovery time	t _{rr}		-	45	70	ns
Body diode reverse recovery charge	Q _{rr}	I _F = -4.2 A, di/dt = 100 A/μs,	-	40	60	nC
Reverse recovery fall time	t _a	$T_{J} = 25 ^{\circ}\text{C}$		23	-	
Reverse recovery rise time	t _a			22		ns

Notes

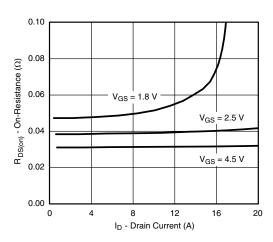
- a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

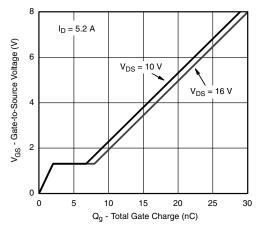




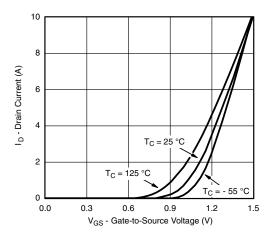
Output Characteristics



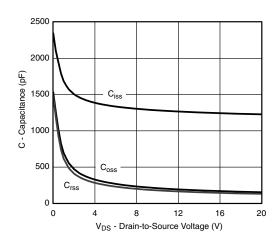
On-Resistance vs. Drain Current and Gate Voltage



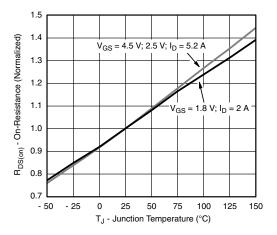
Gate Charge



Transfer Characteristics

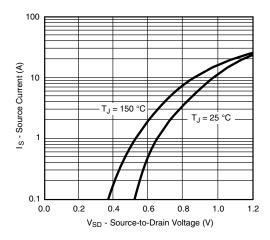


Capacitance

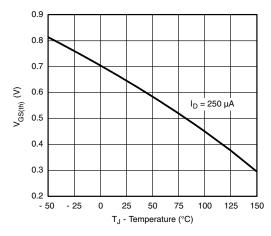


On-Resistance vs. Junction Temperature

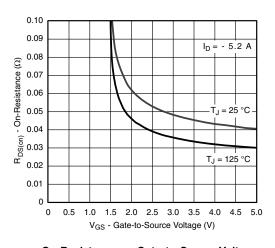




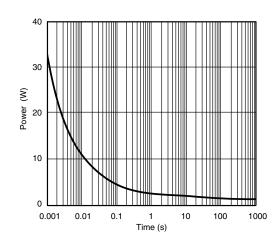
Source-Drain Diode Forward Voltage



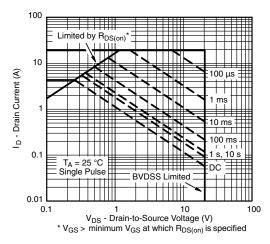
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage

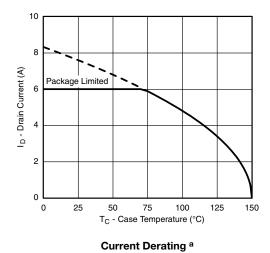


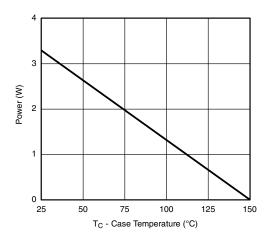
Single Pulse Power



Safe Operating Area





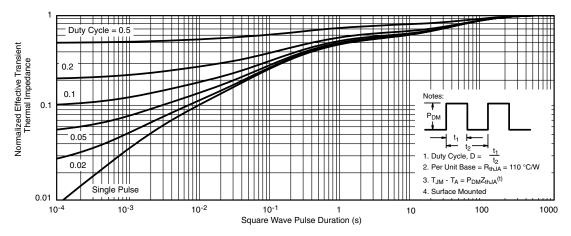


Power, Junction-to-Foot

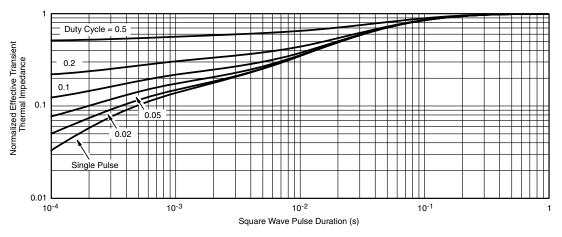
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

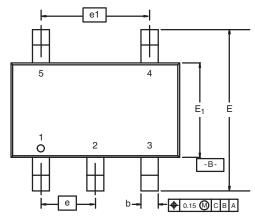
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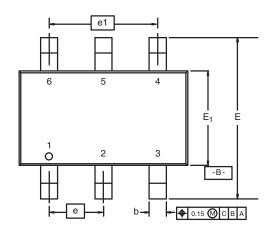




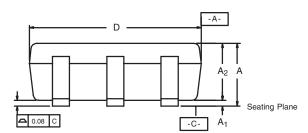
TSOP: 5/6-LEAD

JEDEC Part Number: MO-193C

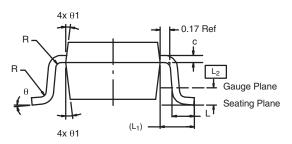




5-LEAD TSOP





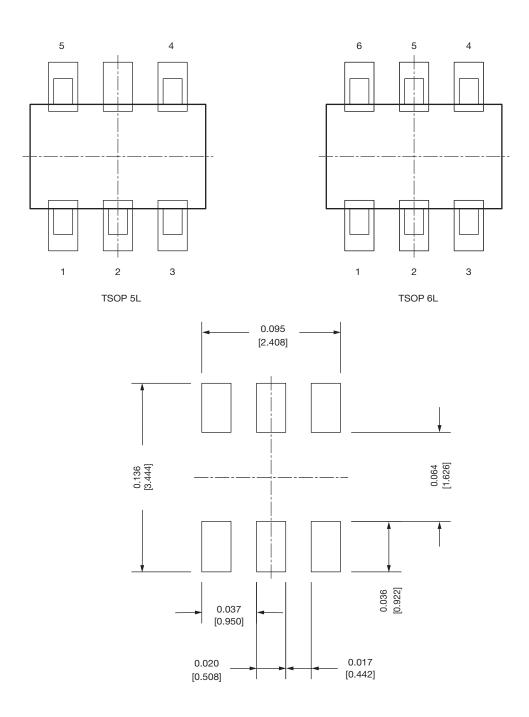


	MIL	LIMETER	RS	INCHES			
Dim	Min	Nom	Max	Min	Nom	Max	
Α	0.91	-	1.10	0.036	-	0.043	
A ₁	0.01	-	0.10	0.0004	-	0.004	
A ₂	0.90	-	1.00	0.035	0.038	0.039	
b	0.30	0.32	0.45	0.012	0.013	0.018	
С	0.10	0.15	0.20	0.004	0.006	0.008	
D	2.95	3.05	3.10	0.116	0.120	0.122	
E	2.70	2.85	2.98	0.106	0.112	0.117	
E ₁	1.55	1.65	1.70	0.061	0.065	0.067	
е		0.95 BSC		0.0374 BSC			
e ₁	1.80	1.90	2.00	0.071	0.075	0.079	
L	0.32	-	0.50	0.012	-	0.020	
L ₁	0.60 Ref			0.024 Ref			
L ₂	0.25 BSC			0.010 BSC			
R	0.10	-	-	0.004	-	-	
θ	0°	4°	8°	0°	4°	8°	
θ1		7° Nom		7° Nom			
ECN: C-06593-Rev. I, 18-Dec-06 DWG: 5540							

Document Number: 71200 18-Dec-06



Recommended Land Pattern For TSOP-5L / TSOP-6L



Note

• All dimensions are in inches (millimeter)

ECN: C22-0860-Rev. B, 24-Oct-2022 DWG: 3010



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